

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	Heat Sink Fan and Method for Manufacturing Heat Sink That Is Used For the Heat Sink Fan		
Application Number :			
Date :			
First Named Applicant:	Mr. Takaya Otsuki		
Confirmation Number:			
Attorney Docket Number:	18.017-AG		
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Submitted By:		Elec. Sign.	Sign. Capacity
James Judge Registered Number: 42,701		jjUDGE	Agent

Documents being submitted:	Files
us-assignment	ND017-usassn.xml us-assignment.xsl us-assignment.dtd assgn.tif
us-request	ND017-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	ND017-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	ND017-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd fig1.tif fig2.tif fig3.tif fig4.tif fig5.tif fig6.tif
us-declaration	dclr01.tif
us-declaration	dclr02.tif
us-declaration	dclr03.tif
Comments	